







Designator	Quantity	Value	Name	Description	Footprint	Model:Footprint	LibRef
C1		1 1uF	Сар	Capacitor	108L	Chip Capacitor 0603	Сар
C2, C33		2 100nF	Сар	Capacitor	CAPC_0603_1608X 08L	Chip Capacitor 0603	Сар
C37, C38, C39, C40, C41		5 22uF	Сар	Capacitor	CAPC3224X25L	Chip Capacitor, 2-Leads, Body 3.20x2.45mm, IPC High Density	Сар
C42		1 100pF	Сар	Capacitor	CAPC_0603_1608X 08L	Chip Capacitor 0603	Сар
D1		1	Schottky 40V 3A	Schottky Diode	SODFL470X110-2L	SODFL, 2-Leads, Body 2.50x4.70mm, IPC High Density	D Schottky
ESP1		1	ESP8266 ESP-12-E	ESP8266 ESP-12-E	ESP8266 ESP-12-E	ESP8266 ESP-12-E	ESP8266 ESP-12-E
L2		1 15uH	Inductor	Inductor	INDP5150X20L	Precision Wire Wound Inductor, 2-Leads, Body 5.15x5.00mm, IPC High Density	Inductor
LED1		1	RGB LED Common anode	Dot is _not_ anode!	PLCC-4	LED	RGB_LED
Q1, Q2, Q3		3	MOSFET-P		DPAK229P994X24 1-3L	D-PAK, 3-Pads, Body 6.21x6.73mm (max), IPC High Density	MOSFET-P
Q4		1	MOSFET-N		SOT23	SOT23, 3-Leads, Body 2.90x2.45mm, Pitch 0.95mm, IPC High Density	MOSFET-N
R1, R2, R3, R4, R5, R14, R23		7 10K	Res2	Resistor		Chip Resistor, 2-Leads, Body 1.60x0.80mm, IPC High Density	Res2
R6, R7, R8, R13, R31		5 1K	Res2	Resistor	RESC_0603_1608X 08L	Chip Resistor, 2-Leads, Body 1.60x0.80mm, IPC High Density	Res2
R11		1 220K	Res2	Resistor	RESC_0603_1608X 08L	Chip Resistor, 2-Leads, Body 1.60x0.80mm, IPC High Density	Res2
R12		1 100K	Res2	Resistor	RESC_0603_1608X 08L	Chip Resistor, 2-Leads, Body 1.60x0.80mm, IPC High Density	Res2
R29		1 2.4K	Res2	Resistor	RESC_0603_1608X 08L	Chip Resistor, 2-Leads, Body 1.60x0.80mm, IPC High Density	Res2
R30		1 680	Res2	Resistor	RESC_0603_1608X 08L	Chip Resistor, 2-Leads, Body 1.60x0.80mm, IPC High Density	Res2
S_FUN1		1	4-1437565-1	Tactile switch	EVQP7C01P	Side actuated tactile switch	4-1437565-1
U1		1	M74VHC1GT125	Level shifter non inverting	SOT65P210X100- 5L	SOT23, 5-Leads, Body 2.00x2.10mm, Pitch 0.65mm, IPC High Density	M74VHC1GT125
U2		1	LDO 5V	J	Micro8 TSOP	TSOP, 8-Leads	LDO LP2950 5V
U3		1	BD9G101G-LB		TSOP95P280X125- 6L	TSOP, 6-Leads, Body 2.90x1.65mm, Pitch 0.95mm, IPC High Density	BD9G102G-LB

Design Rules Verification ReportFilename: C:\Dev\wifi-christmas-tree-lights\pcbs\controller_8266\controller_8266.PcbDoc

Warnings 0 Rule Violations 0

Warnings	
Total	0

Rule Violations	
Clearance Constraint (Gap=5mil) (All),(IsKeepOut)	0
Clearance Constraint (Gap=20mil) (InNetClass('POWER24') And ((IsPad And (InNet('GND') Or InNet('VCC_LED'))) Or	0
Clearance Constraint (Gap=5mil) (All),(All)	0
Clearance Constraint (Gap=-3.937mil) (InPadClass('AGND_TIE')),(InNet('GND') And OnBottomLayer)	0
Clearance Constraint (Gap=20mil) (InNet('PS_GATE') And (Not WithinRoom('LowPowerRoom'))), (InNet('VCC24'))	0
Short-Circuit Constraint (Allowed=Yes) (InPadClass('AGND_TIE')),(InNet('GND'))	0
Short-Circuit Constraint (Allowed=No) (All),(All)	0
Un-Routed Net Constraint ((All))	0
Modified Polygon (Allow modified: No), (Allow shelved: No)	0
Width Constraint (Min=5mil) (Max=50mil) (Preferred=5mil) (All)	0
Routing Via (Templates Used To Check Via: gnd_stitch, power_via, signal_routing) (All)	0
Power Plane Connect Rule(Relief Connect)(Expansion=20mil) (Conductor Width=5mil) (Air Gap=5mil) (Entries=4) (All)	0
Minimum Annular Ring (Minimum=5.118mil) (IsPad)	0
Minimum Annular Ring (Minimum=5.118mil) (IsVia)	0
Acute Angle Constraint [Tracks Only] (Minimum=45.000) (All)	0
Hole Size Constraint (Min=11.811mil) (Max=248.031mil) (All)	0
Hole To Hole Clearance (Gap=7.874mil) (All),(All)	0
Minimum Solder Mask Sliver (Gap=7.874mil) (All),(All)	0
Net Antennae (Tolerance=0mil) (All)	0
Board Clearance Constraint (Gap=0mil) (InLayerClass('Electrical Layers'))	0
LowPowerRoom (Bounding Region = (39504.59mil, 40260.392mil, 40172.144mil, 40418.41mil)	0
Component Clearance Constraint (Horizontal Gap = 0mil, Vertical Gap = 0mil) (All),(InComponentClass('TestPoint'))	0
Component Clearance Constraint (Horizontal Gap = 0mil, Vertical Gap = Infinite) (All),(All)	0
Height Constraint (Min=0mil) (Max=1000mil) (Prefered=500mil) (All)	0
Total	0

Page 1 of 1 Tuesday 23 Jun 2020 6:23:19 PN.